

Overview

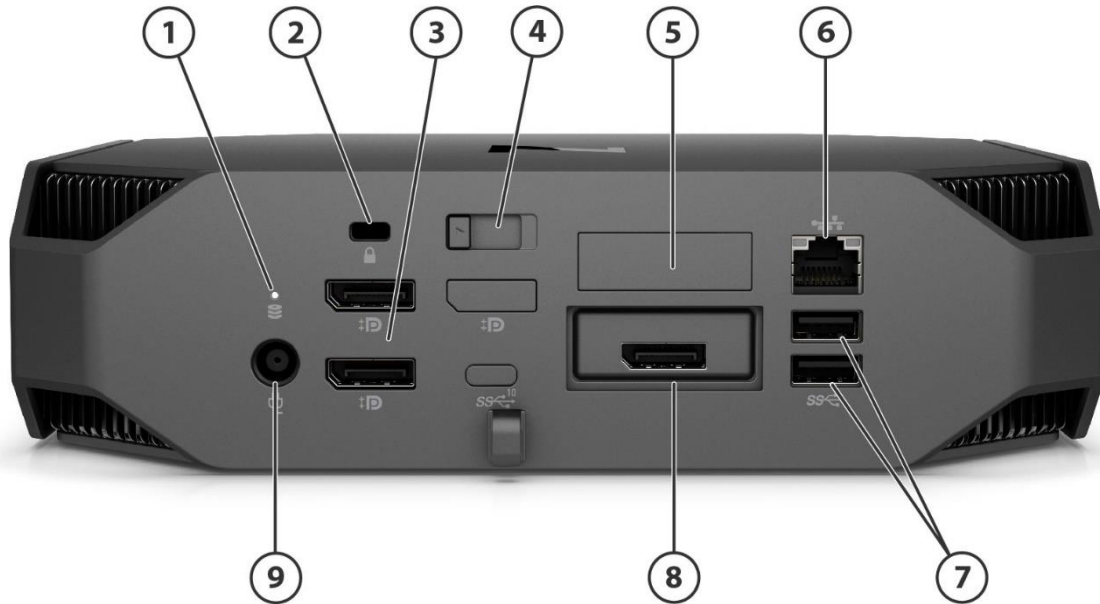
HP Z2 Mini G4 Workstation



Front View

1. Power Button
2. Headphones/Microphone combo port
3. USB 3.0 charging data port
4. USB 3.0 data port
5. (1) USB Type C™

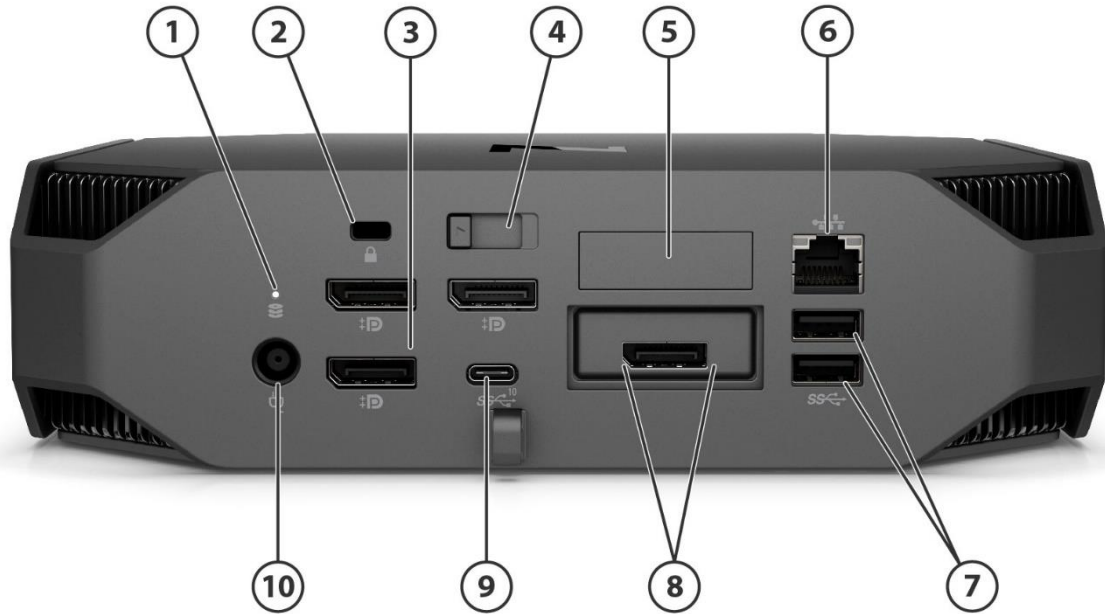
Overview



HP Z2 Mini G4 Entry, back view

- | | |
|---------------------------|---|
| 1. HDD LED | 6. RJ-45 (Ethernet) |
| 2. Security slot | 7. (2) USB 3.0 ports |
| 3. (2) DisplayPort™ | 8. Flexible IO module (supports VGA/HDMI/DisplayPort™/2 nd RJ-45/USB-C 3.1 Gen2 Charging Data Port/Thunderbolt™ 3.0) |
| 4. Cover latch | 9. DC In |
| 5. Serial port (optional) | |

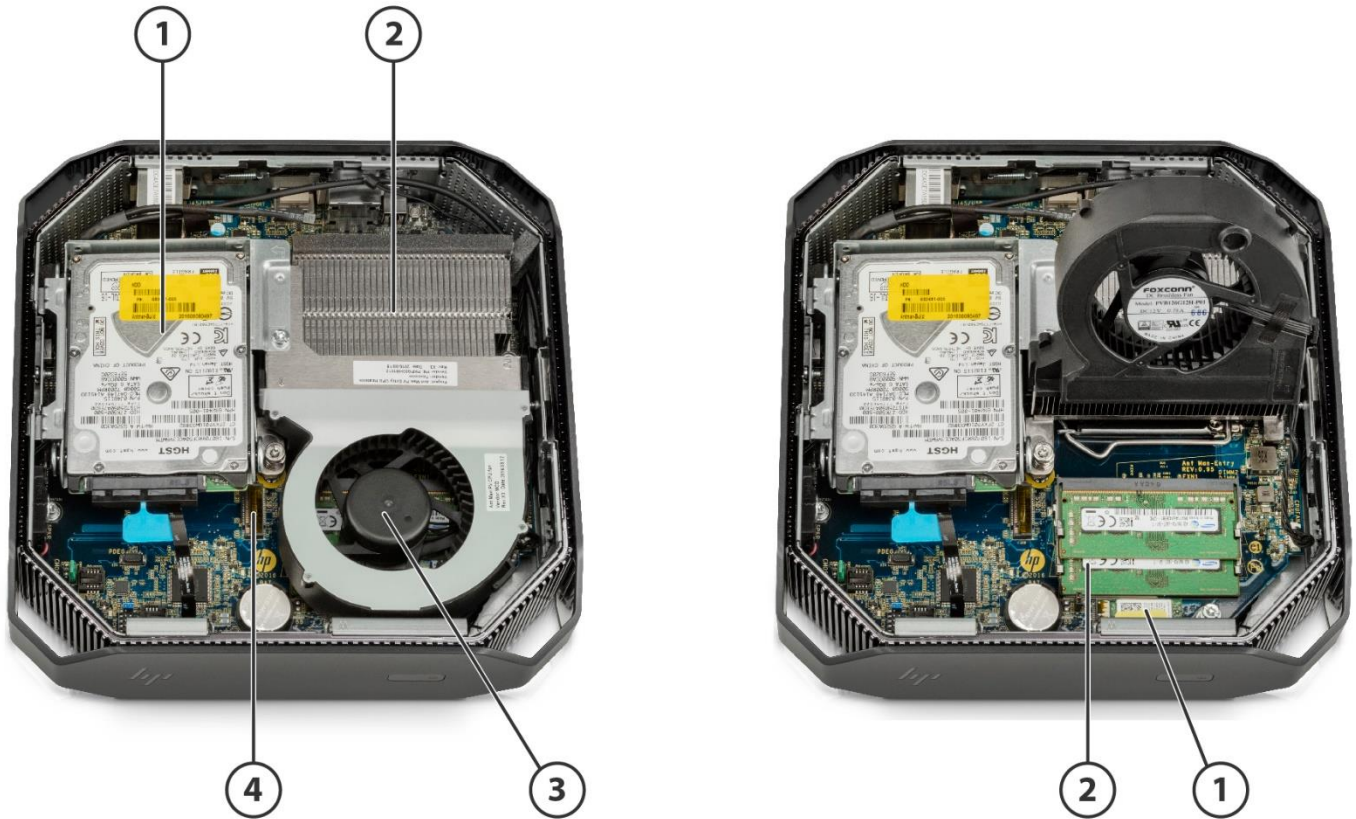
Overview



HP Z2 Mini G4 Performance, back view

- | | | | |
|----|------------------------|-----|--|
| 1. | HDD LED | 7. | (2) USB 3.0 ports |
| 2. | Security slot | 8. | Flexible IO module (supports
VGA/HDMI/DisplayPort™/2 nd RJ-45/USB-C 3.1 Gen2
Charging Data Port/Thunderbolt™ 3.0) |
| 3. | (3) DisplayPort™ | 9. | (1) USB Type C™ |
| 4. | Cover latch | 10. | DC In |
| 5. | Serial port (optional) | | |
| 6. | RJ-45 (Ethernet) | | |

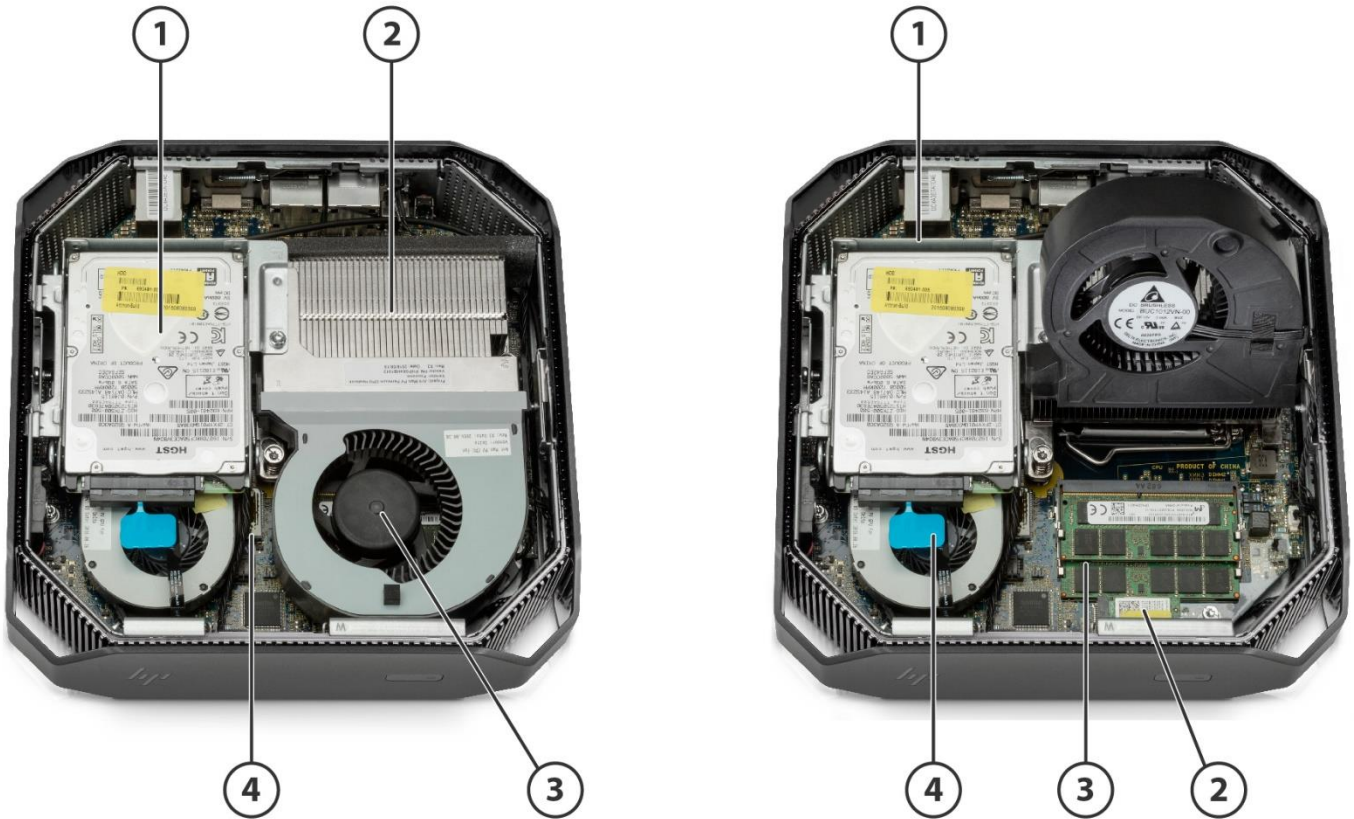
Overview



HP Z2 Mini G4 Entry, Internal View

- | | |
|------------------------------|--|
| 1. SATA HDD/SSD (9.5mm 2.5") | 1. M.2 30mm WLAN/BT (location change, TBD) |
| 2. CPU heatsink | 2. (2) SODIMM memory slots |
| 3. CPU blower | |
| 4. M.2 80mm (PCIe SSD) | |

Overview



HP Z2Mini G4 Performance, Internal View

- | | |
|------------------------------|--|
| 1. SATA HDD/SSD (9.5mm 2.5") | 1. GPU heatsink (underneath HDD/SSD cage) |
| 2. CPU heatsink | 2. M.2 30mm WLAN/BT (location change, TBD) |
| 3. CPU blower | 3. (2) SODIMM memory slots |
| 4. M.2 80mm (PCIe SSD) | 4. GPU blower |

Overview



HP Z2 G4 Mini, bottom view (TBD)

Removable bottom feet for access to integrated VESA mounting holes

Overview

Form Factor

Mini Form Factor

Operating Systems

Preinstalled:

- Windows 10 Home¹
- Windows 10 Pro 64¹
- Windows 10 Pro License MSNA¹
- Windows 10 Pro for Workstations¹
- HP Linux® -ready
- Red Hat® Enterprise Linux Workstation (1 year paper license available; Preinstall not available)

Supported:

- Red Hat® Enterprise Linux Desktop 7.5
 - SUSE Linux® Enterprise Desktop 12 SP3
- Notes:** For detailed OS/hardware support information for Linux, see: http://www.hp.com/support/linux_hardware_matrix
1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>
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Overview

Processors*

Name	Cores	Clock Speed (GHz)	Intel® Turbo Boost Technology ³	Cache (MB)	Memory Speed (MT/s)	Hyper-Threading	Integrated Graphics	Featuring Intel® vPro™ Technology ⁴	16GB Intel® Optane™ memory ²	TDP (W)
Z2 Mini G4 Performance base unit										
Intel® Xeon® processor E-2176G ¹	6	3.7	4.7	12	2666	Y	Intel® UHD Graphics P630	Y	N	80W
Intel® Xeon® processor E-2174G ¹	4	3.8	4.7	8	2666	Y	Intel® UHD Graphics P630	Y	N	71W
Intel® Xeon® processor E-2144G ¹	4	3.6	4.5	8	2666	Y	Intel® UHD Graphics P630	Y	N	71W
Intel® Xeon® processor E-2136 ¹	6	3.3	4.5	12	2666	Y	N/A	Y	N	80W
Intel® Xeon® processor E-2126G ¹	6	3.3	4.5	12	2666	N	Intel® UHD Graphics P630	Y	N	80W
Intel® Xeon® processor E-2124G ¹	4	3.4	4.3	8	2666	N	Intel® UHD Graphics P630	Y	N	71W
Intel® Xeon® processor E-2104G ¹	4	3.2	N/A	8	2666	N	Intel® UHD Graphics P630	Y	N	65W
Intel® Core™ i7-8700 processor ¹	6	3.2	4.6	12	2666	Y	Intel® UHD Graphics 630	Y	N	65W
Intel® Core™ i7+8700 processor (Core i7 and 16GB Intel® Optane™ memory) ^{1,2}	6	3.2	4.6	12	2666	Y	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core™ i5-8600 processor ¹	6	3.1	4.2	9	2666	N	Intel® UHD Graphics 630	Y	N	65W
Intel® Core™ i5+8600 processor (Core i7 and 16GB Intel® Optane™ memory) ^{1,2}	6	3.1	4.2	9	2666	N	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core™ i5-8500 processor ¹	6	3.0	4.0	9	2666	N	Intel® UHD Graphics 630	Y	N	65W
Intel® Core™ i5+8500 processor (Core i7 and 16GB Intel® Optane™ memory) ^{1,2}	6	3.0	4.0	9	2666	N	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core™ i3-8100 processor ¹	4	3.6	N/A	6	2400	N	Intel® UHD Graphics 630	N	N	65W
Intel® Core™ i3+8100 processor (Core i7 and 16GB Intel® Optane™ memory) ^{1,2}	4	3.6	N/A	6	2400	N	Intel® UHD Graphics 630	N	Y	65W

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Intel® Pentium™ G5400 processor ¹	2	3.7	N/A	4	2400	Y	Intel® UHD Graphics 630	N	N	54W
Z2 Mini G4 Entry base unit										
Intel® Xeon® processor E-2104G ¹	4	3.2	N/A	8	2666	N	Intel® UHD Graphics P630	Y	N	65W
Intel® Core™ i7-8700 processor ¹	6	3.2	4.6	12	2666	Y	Intel® UHD Graphics 630	Y	N	65W
Intel® Core™ i7+8700 processor (Core i7 and 16GB Intel® Optane™ memory) ^{1,2}	6	3.2	4.6	12	2666	Y	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core™ i5-8600 processor ¹	6	3.1	4.2	9	2666	N	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core™ i5+8600 processor (Core i7 and 16GB Intel® Optane™ memory) ^{1,2}	6	3.1	4.2	9	2666	N	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core™ i5-8500 processor ¹	6	3.0	4.0	9	2666	N	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core™ i5+8500 processor (Core i7 and 16GB Intel® Optane™ memory) ^{1,2}	6	3.0	4.0	9	2666	N	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core™ i3-8100 processor ¹	4	3.6	N/A	6	2400	N	Intel® UHD Graphics 630	N	Y	65W
Intel® Core™ i3+8100 processor (Core i7 and 16GB Intel® Optane™ memory) ^{1,2}	4	3.6	N/A	6	2400	N	Intel® UHD Graphics 630	N	Y	65W
Intel® Pentium™ G5400 processor ¹	2	3.7	N/A	4	2400	Y	Intel® UHD Graphics 630	N	N	54W

¹Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

²Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system.

³The specifications shown in the Intel® Turbo Boost Technology column represent the maximum turbo frequency with one core active. Turbo boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See <http://www.intel.com/technology/turboboost> for more information.

⁴vPro. Some functionality of this technology, such as Intel® Active management technology and Intel® Virtualization technology, requires additional 3rd party software in order to run. Availability of future “virtual appliances” applications for Intel vPro technology is dependent on third-party software providers. Compatibility of this generation of Intel vPro technology-based hardware with future “virtual appliances” is yet to be determined.

NOTES:



Overview

Integrated Intel® HD graphics P530 is supported on all Intel® Xeon® E processors.

Intel® Xeon® E, Intel® Core™ i3 and Pentium can support either ECC or non-ECC memory; Intel® Core™ i5/i7 processors only support non-ECC memory.

NOTE: In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <http://www.support.hp.com>.

Color	Space grey with black chrome accents
Convertibility	The Z2Mini G4 can either be placed flat on the desktop or mounted behind a display* or under a desk. * Mounting hardware sold separately.
Expansion Slots (see system board section for more details)	1 MXM slot (PCIe Gen3 x16) * 1 80mm M.2 Storage slot (PCIe Gen3 x4) 1 30mm M.2 WLAN slot (PCIe Gen3 x1) ** * Performance only ** For WLAN/BT M.2 module only
Expansion Bays (see system board section for more details)	1 internal 2.5" bay (for For SATA HDDs & SSDs only only)
Front I/O	Power button
Slide I/O	1 USB-A 3.0 Charging Data Port, 1 USB 3.0 data port, combo headset/microphone port and 1 USB-C 3.1 Gen2 Charging Data Port.
Rear I/O	Z2 Mini G4 Entry: 2 DisplayPort™ (DP 1.2) outputs from Intel® HD graphics, 2 USB 3.0 ports, 1 serial port (optional), RJ-45 (LoM) 1 Flexible module port output (Optional Flexible module required) Z2 Mini G4 Performance¹: 3 DisplayPort™ (DP 1.2) outputs from discrete graphic module, 2 USB-A 3.0 ports, 1 USB 3.1 G2 Type-C™ ports, 1 serial port (optional),RJ-45 (LoM) 1 Flexible module port output (Optional Flexible module required) NOTE 1: Capable of supporting 6 displays. 6 display solution is achieved using a combination of Intel® HD graphics and NVIDIA® Quadro® graphics is ONLY supported on Windows 10.
Chassis Dimensions (H x W x D)	Standard desktop orientation: 58 x 216 x216 mm (2.28 x 8.5 x 8.5 in)
Weight	Exact weights depend upon configuration; Minimum Weight: 1.93 kg (4.25 lb) Typical Weight*: 2.18 kg (4.80 lb) Maximum Weight: 2.23 kg (4.91 lb) Max Supported Weight (desktop orientation): 35 kg (77 lb) * Configured with 1 2.5" hard drive, 1 PCIe SSD, WLAN module, 2 DIMMs and 1 NVIDIA® Quadro® graphics card
Temperature	Operating: 40° to 95°F (5° to 35°C)

Overview

Non-operating: -40° to 140°F (-40° to 60°C)

Notes: Derate the maximum operating temperature by one degree C (1.8 degrees F) for every 305m (1,000 ft) altitude over 1,524m (5,000 ft).

Humidity

Operating: 8% to 85%
Non-operating: 8% to 90%

Maximum Altitude (non-pressurized)

Operating: 3,000 m (10,000 ft)
Non-operating: 9,100 m (30,000 ft).

Power Supply

Z2 Mini G4 Entry:
135W 88% Efficiency at 115Vac

Z2 Mini G4 Performance:
200W 89% Efficiency at 230Vac
230W

NOTES: Customers placing their system in an enclosure should design their solution to accommodate the size of the external power supply for the Z2 Mini G4

Chipset

Intel® C246 chipset

Memory

2 SODIMM slots, supporting up to 32GB ECC/non-ECC, DDR4 2666 MT/s

The CPUs determine the speed at which the memory is clocked. If a 2666 MT/s capable CPU is used in the system, the maximum speed the memory will run at is 2666 MT/s regardless of the specified speed of the memory.

Note: Transfer rates up to 2666MT/s

Workstation ISV Certifications

See the latest list of certifications at
<http://www.hp.com/united-states/campaigns/workstations/partnerships.html>

Supported Components

Processors

	Factory Configured	Option Kit
Intel® Xeon® processor E-2100 family²		
Intel® Xeon® processor E-2176G ¹	Y	N
Intel® Xeon® processor E-2174G ¹	Y	N
Intel® Xeon® processor E-2144G ¹	Y	N
Intel® Xeon® processor E-2136 ¹	Y	N
Intel® Xeon® processor E-2124G ¹	Y	N
Intel® Xeon® processor E-2104G	Y	N
8th generation Intel® Core™ processor family³		
Intel® Core™ i7-8700 3.2 26666 6C CPU	Y	N
Intel® Core™ i7+8700 (Core i7 and 16GB Intel® Optane™ memory) 3.2 26666 6C CPU	Y	N
Intel® Core™ i5-8600 3.1 2666 6C CPU	Y	N
Intel® Core™ i5+8600 (Core i7 and 16GB Intel® Optane™ memory) 3.1 2666 6C CPU	Y	N
Intel® Core™ i5-8500 3.0 2666 6C CPU	Y	N
Intel® Core™ i5+8500 (Core i7 and 16GB Intel® Optane™ memory) 3.0 2666 6C CPU	Y	N
8th generation Intel® Core™ i3/Pentium processor family²		
Intel® Core™ i3-8100 3.6 2400 4C CPU	Y	N
Intel® Core™ i3+8100 (Core i7 and 16GB Intel® Optane™ memory) 3.6 2400 4C CPU	Y	N
Intel® Pentium® G5400 3.7 2400 2C CPU	Y	N

NOTE 1: Only supported on Z2 Mini G4 Performance Base Unit

NOTE 2: These processor support either ECC or non-ECC memory

NOTE 3: These processors support only non-ECC memory

NOTE 4: Intel® Integrated Graphics P630 for Xeon® processors supports workstation-specific graphics drivers for improved compatibility and performance on select professional applications, compared to Intel® HD Graphics 630.

NOTE 5: Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system.

Monitors / Displays

	Factory Configured	Option Kit	Option Kit Part Number
HP Z Display Z27n G2 27-inch IPS LED Backlit Monitor		Y	1JS10AA
HP Z Display Z24n G2 24-inch IPS LED Backlit Monitor		Y	1JS09AA
HP Z Display Z24nf G2 23.8-inch IPS Backlit Monitor		Y	1JS07AA
HP Z Display Z23n G2 23-inch IPS LED Backlit Monitor		Y	1JS06AA
HP Z Display Z22n G2 21.5-inch IPS LED Backlit Monitor		Y	1JS05AA

Notes

Supported by all Operating Systems available from HP
Screen Size Diagonally Measured

Supported Components

Supported Components

SATA Hard Drives		Factory Configured	Option Kit	Option Kit Part Number
	500GB SATA 7200 rpm 6Gb/s SFF HDD	Y	Y	T0K73AA
	1TB SATA 7200 rpm 6Gb/s SFF HDD	Y	Y	T0K74AA
SATA Solid State Drives				
	HP 256GB SATA 6Gb/s SSD	Y	Y	A3D26AA
	16GB Intel® Optane™ memory*	Y	Y	TDB

*Intel® Optane™ memory (cache) is sold separately. Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system. Available for HP commercial desktops and notebooks and for select HP workstations (HP Z240 Tower/SFF, Z2 Mini, ZBook Studio, 15 and 17 G5) and requires a SATA HDD, 7th Gen or higher Intel® Core™ processor or Intel® Xeon® processor E3-1200 V6 product family or higher, BIOS version with Intel® Optane™ supported, Windows 10 version 1703 or higher, M.2 type 2280-S1-B-M connector on a PCH Remapped PCIe Controller and Lanes in a x2 or x4 configuration with B-M keys that meet NVMe™ Spec 1.1, and an Intel® Rapid Storage Technology (Intel® RST) 15.5 driver.

PCIe SSDs	PCIe SSDs for HP Workstations	Factory Configured	Option Kit	Option Kit Part Number
	HP Z Turbo Drive G2 256GB TLC (Z2 Mini G4)	Y	Y	Y7B60AA
	HP Z Turbo Drive G2 512GB TLC (Z2 Mini G4)	Y	Y	
	HP Z Turbo Drive G2 1TB TLC (Z2 Mini G4)	Y	Y	

** Installed in native M.2 storage slot on Z2 Mini G4 motherboard

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows 10) of system disk is reserved for system recovery software.

Graphics		Factory Configured	Option Kit	Option Kit Part Number	Supported # of cards
Integrated Graphics					
	Integrated Intel® HD Graphics (Z2G4)				
	Intel® HD Graphics P630	Y	N		1
	Intel® HD Graphics 630	Y	N		1
	Intel® HD Graphics 610	Y	N		1
Discrete Graphics					
	NVIDIA® Quadro® P600 4GB Graphics ¹	Y	Y	3TQ28AA	1
	NVIDIA® Quadro® P1000 4GB Graphics ¹	Y	Y	3TQ29AA	1
	AMD Radeon™ Pro WX 4150 4GB Graphics ¹	Y	Y	3TQ30AA	1
Graphics DisplayPort™ Cable Adapters					
	HP DisplayPort™ To DVI-D Adapter	Y	Y	FH973AA	
	HP DisplayPort™ To VGA Adapter	N	Y	AS615AA	
	HP DisplayPort™ to Dual Link DVI Adapter	N	Y	NR078AA	
	HP Display to HDMI Adapter	N	Y		
	HP USB-C to VGA Adapter	N	Y		
	HP USB-C to HDMI Adapter	N	Y		
	HP USB-C to DP Adapter	N	Y		

Notes

NOTE 1: Only offered on Z2 Mini G4 Performance base unit

Supported Components

NOTE: Intermixing integrated Intel® HD graphics and discrete graphics cards in order to drive more than three displays can be enabled using the Computer (F10) Setup Utility. However, HP recommends using only discrete graphics when four or more displays are required to be supported. 6 display solution is achieved using a combination of Intel® HD graphics and NVIDIA® Quadro® graphics is ONLY supported on Windows 10.

Supported Components

Memory

DDR4-2400 ECC Unbuffered SODIMMs - CTO

HP 8GB (1x8GB) DDR4-2666 ECC SODIMM
 HP 16GB (2x8GB) DDR4-2666 ECC SODIMM
 HP 32GB (2x16GB) DDR4-2666 ECC SODIMM

DDR4-2400 non-ECC Unbuffered SODIMMs - CTO

HP 4GB (1x4GB) DDR4-2666 nECC SODIMM
 HP 8GB (2x4GB) DDR4-2666 nECC SODIMM
 HP 8GB (1x8GB) DDR4-2666 nECC SODIMM
 HP 16GB (2x8GB) DDR4-2666 nECC SODIMM
 HP 32GB (2x16GB) DDR4-2666 nECC SODIMM

NOTES: Intel® Xeon® E, Intel® Core™ i3 and Intel® Pentium® processors can support either ECC or non-ECC memory; Intel® Core™ i5/i7 processors only support non-ECC memory.

Two channels of DDR4 memory are supported. To realize full performance at least one DIMM must be inserted into each channel.

The CPUs determine the speed at which the memory is clocked. If a 2666 MT/s capable CPU is used in the system, the maximum speed the memory will run at is 2666 MT/s regardless of the specified speed of the memory.

AMO

Option Kit Part Number

DDR4-2400 ECC Unbuffered SODIMMs - AMO

HP 8GB (1x8GB) DDR4-2666 ECC RAM	3TQ37AA
HP 16GB (1x16GB) DDR4-2666 ECC SODIMM	3TQ38AA
HP 4GB (1x4GB) DDR4-2666 non-ECC RAM	3TQ34AA
HP 8GB (1x8GB) DDR4-2666 non-ECC RAM	3TQ35AA
HP 16GB (1x16GB) DDR4-2666 non-ECC RAM	3TQ36AA

NOTE: Only unbuffered DDR4 SODIMMs are supported.

Multimedia and Audio Devices

Integrated Conexant CX20632 5.1 HAD Audio

Factory Configured

Y

Option Kit

N

Option Kit Part Number

Optical and Removable Storage

HP SlimTray Optical Drives

HP External Ultra-Slim DVD-RW Drive

Factory Configured

N

Option Kit

Y

Option Kit Part Number

Y3T76AA

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer

Supported Components

discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Networking and Communications

	Factory Configured	Option Kit	Option Kit Part Number
Integrated Intel® I219LM PCIe GbE Controller (Intel® vPro™ with Intel® AMT 11.0)	Y	N	
Intel® 9560 Wireless LAN (802.11ac) and Bluetooth® 5 Module	Y	N	

NOTE 1: The integrated network connection is required to support Intel® vPro™ Technology.

NOTE 2: If AMT is provisioned, then network teaming with the integrated LAN port is not possible.

NOTE 3: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Racking and Physical Security

	Factory Configured	Option Kit	Option Kit Part Number
HP Keyed Cable Lock 10mm	N	Y	T1A62AA

Input Devices

	Factory Configured	Option Kit	Option Kit Part Number
HP USB Optical Mouse	Y	Y	QY777AA
HP USB Hardened Mouse	Y	Y	P1N77AA
3Dconnexion CADMouse	Y	Y	M5C35AA
HP USB CCID SmartCard Keyboard	Y	Y	BV813AA
HP USB Business Slim Keyboard	Y	Y	N3R87AA
HP Wireless Business Slim Keyboard	Y	Y	
HP USB Optical Mouse	Y	Y	QY777AA

Other Hardware

	Factory Configured	Option Kit	Option Kit Part Number
HP Serial Port Adapter	Y	N	PA716A
HP Z2 Mini G4 VESA Sleeve	N	Y	Y7B61AA
Z2 Mini G4 Z Display VESA Mount Solution - Current Displays	N	Y	N6N00AA*
Z2 Mini G4 Z Display VESA Mount Solution - Legacy Displays	N	Y	E5J35AA**
HP Elite USB-C Docking Station (TBD)	N	Y	

Supported Components

* Current: "n" displays. This mounting kit supports the following displays:
Z2G42n/Z2G43n/Z2G44n/Z2G45n/Z2G47n,
/Z2G44nf/Z2G44nq/Z2G44s/Z2G47q/Z32s/Z32x/HC240/HC270/E240c/E272.

** Legacy: "l" displays. This mounting kit supports the following displays: Z2G44i/Z2G47i/Z30i,
/Z30i/Z2G44x/Z2G47x.

Rear Module Options

	Factory Configured	Option Kit	
HP Flex IO module (VGA)	Y	Y	3TK80AA
HP Flex IO module (HDMI-iGfx)	Y	Y	3TK74AA
HP Flex IO module (DP)	Y	Y	3TK72AA
HP Flex IO module (USB-C)	Y	Y	4KY84AA
HP Flex IO module (Thunderbolt™ 3.0)	Y	Y	3TQ25AA
HP Flex IO module (1 GbE LAN)	Y	Y	3TQ26AA
HP FiberNIC 1 GbE module	Y	Y	
HP Serial Port Mini module	Y	Y	3TQ27AA

Software

	Factory Configured	Option Kit	Support Notes
Intel® Unite™	Y	N	
HP Performance Advisor	Y	N	See Note 1
HP Remote Graphics Software (RGS) 7.1	Y	N	
HP PC Hardware Diagnostics UEFI	Y	N	See Note 2
HP Client Security Software	Y	N	

NOTE 1: Supports, and preinstalled with Windows 10 only. Also available as a free download from <http://www.hp.com/go/performanceadvisor>

NOTE 2: Windows OS only

Operating Systems

Windows 10 Home
Windows 10 Pro 64
Windows 10 Pro License MSNA
Windows 10 Pro for Workstations
Red Hat® Enterprise Linux® (RHEL) Workstation - Paper License (1yr)
See <http://www.microsoft.com/windows/windows-7/> for support details.
See <http://www.redhat.com/rhel/desktop/>

Remote Power On

Benefits of the Remote Power:

- Make it easier to power-on HP Z2 Mini G4 Workstation by USB keyboard/mouse in some use scenarios.
- Support wired/wireless, USB low speed/full speed keyboards and mouses.
- Easy setup in BIOS menu.
- Support waking from both S4 (Hibernate) and S5 (Shutdown).

Supported Components

Limitations:

- Waking from S4/S5 is limited to only via keyboard/mouse device.

Instructions:

1. Connect USB keyboard/mouse to USB port.
2. System must recognize USB keyboard/mouse in S0 first. (USB full speed keyboard/mouse, such as wireless keyboard/mouse or Smart card keyboard need to connect to system over 60 seconds in S0 to be recognized on charging port.)
3. Sleep to S4 or S5.
4. Wake system by any key on keyboard or clicking/movement* on mouse.

* If mouse has the capability to wake system by movement

System Technical Specifications

System Board

System Board Form Factor	Entry: 200mm x 200mm (7.9 x 7.9 inches) Performance: 200mm x 200mm (7.9 x 7.9 inches)
Processor Socket	Single LGA 1151
CPU Bus Speed	DMI link between CPU & PCH: Performance comparable to PCIe Gen3 x4
Chipset	Intel® PCH C246
Memory Expansion Slots	2 SODIMM DDR4 memory slots
Memory Type Supported	DDR4, UDIMM (Unbuffered), ECC & non-ECC
Memory Modes	Non-Interleaved for single channel. Interleaved when both channels are populated.

Memory Speed Supported 2666MHz DDR4 for Coffeelake processors;

Memory Protection ECC available on data
*Requires ECC DIMMs to be installed, as well as a CPU that supports ECC

Maximum Memory 32GB

Memory Configuration (Supported) 4GB, 8GB and 16GB non-ECC/ 8GB and 16GB ECC unbuffered DIMMs are supported. ECC and non-ECC memory DIMMs cannot be mixed on the same system.

Notes [Maximum memory capacities assume 64-bit operating systems, such as Windows® 10 Professional 64-Bit or Red Hat Linux 64-bit.](#)

Supported Drive Interfaces **SATA** Integrated (1) Serial ATA interfaces (6Gb/s SATA).

Integrated Graphics Intel® HD Graphics 610 (on Pentium™ Gold-5xxx processors);
Intel® HD Graphics 630 (on Core™ i3/i5/i7-8xxx processors);
Intel® HD Graphics P630 for Xeon® E processors based on Unified Memory Architecture (UMA).

A region of system memory is reserved and dedicated to the graphics display.

Support for Microsoft DirectX 12.1, OpenGL 4.4 and OpenCL 2.0 on Intel® HD Graphics P630.

(2) DP 1.2 graphics ports integrated on motherboard; (1) DP 1.2 graphic capable through use of Flexible DP module. Supports up to three simultaneous displays across DP outputs. (Entry)
Max. resolution supported: 4096x2160 @60Hz

(1) DP 1.2 graphics ports integrated on motherboard switchable between intel® graphic and discrete graphic; (1) DP 1.2 graphic capable through use of Flexible DP module switchable between intel® graphic and discrete

System Technical Specifications

graphic. Supports up to three simultaneous displays from Intel® graphic across DP outputs. (2) DP 1.2 graphic port dedicated for display from discrete graphics (Performance)
Max. resolution supported: 4096x2160 @60Hz

Network Controller

Integrated Ethernet PHY Connection I219LM. Management capabilities: WOL, PXE 2.1 and AMT 11.0

Serial

1 rear port (configurable option)

IEEE 1394 Connector(s)

USB Connector(s)

Front

Side I/O:
2 USB 3.0 Type-A
1 USB 3.1 G1 Type-C™

Rear

2 USB 3.0 Type-A
1 USB 3.1 G2 Type-C™ (Z2 Mini G4 Performance only)

HD Integrated Audio

Yes; supports CTIA headset

Flash ROM

Yes

Chassis Fan Header

Yes
Additional CPU/GFX Cooler (Z2 Mini G4 Performance only)

Front Control Panel/Speaker Header

Side I/O: Yes

CMOS Battery Holder - Lithium

Yes

Integrated Trusted Platform Module

Integrated TPM 2.0

Power Supply Headers

Yes, single DC-in jack for external power supplies

Power Switch, Power LED & Hard Drive LED Header

1. The power and failure LED are combined in the front power switch.
2. The HDD LED & DC-in LED are combined within one port on the Rear I/O. The LED will be lit once the AC power is plugged in. As soon as the system is booted up, the LED will function as a standard HDD activity LED.

Clear Password Jumper Keyboard/Mouse

Yes
USB

Power Supply

Z2 Mini G4 Entry: 135W, 88% efficiency, wide-ranging, active PFC Power Supply

Z2 Mini G4 Performance: 200W, 89% efficiency, wide-ranging, active PFC Power Supply
Z2 Mini G4 Performance: 230W, 89% efficiency, wide-ranging, active PFC Power Supply

The Z2 Mini G4 PSU Efficiency Report can be found at this link: TBD

Operating Voltage Range

115-230 VAC

Rated Voltage Range

100–240 VAC

Rated Line Frequency

50-60 Hz

Operating Line Frequency Range

47–63 Hz

Rated Input Current

Z2 Mini G4 Entry: 1.9A @ 90Vac

System Technical Specifications

Z2 Mini G4 Performance: 2.9A @ 90Vac

Heat Dissipation Typical: TBD btu/hr (TBD kcal/hr)
Maximum: TBD btu/hr (TBD kcal/hr)

ENERGY STAR® certified (Config Dependent) Yes

FEMP Standby Power Compliant Yes, with Wake-on-LAN disabled: <1W in S5- Power Off

Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V) Yes

System Configurations

Z2 Mini G4 Configuration #1 (TBD)	Processor Info	1x Intel® Xeon® E3-1245v5 3.5 8M GT2 4C
	Memory Info	32GB (2x16GB) DDR4-2400 ECC SO-DIMM
ENERGY STAR CERTIFIED	Graphics Info	NVIDIA® Quadro® P1000M GPU
	Disks/Optical/Floppy	1x 1TB 7200 RPM SATA HDD / 1x Z Turbo Drive G2 512GB PCIe 1st SSD
	Power Supply	200W EPS
	Other	Ethernet Capable

Energy Consumption (Watts)

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows long Idle (S0)	TBD		TBD		TBD	
Windows short Idle (S0)	TBD		TBD		TBD	
Windows Busy Typ(S0)	TBD		TBD		TBD	
Windows Busy Max (S0)	TBD		TBD		TBD	
Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD
Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
Zero Power Mode (ErP)	TBD		TBD		TBD	

Heat Dissipation (Btu/hr)

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
Windows long Idle (S0)	TBD		TBD		TBD	
Windows short Idle (S0)	TBD		TBD		TBD	
Windows Busy Typ(S0)	TBD		TBD		TBD	
Windows Busy Max (S0)	TBD		TBD		TBD	
Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD
Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
Zero Power Mode (ErP)	TBD		TBD		TBD	

Z2 Mini G4 Configuration #2 (TBD)	Processor Info	1x Intel® Xeon® E3-1225v5 3.3 8M GT2 4C
	Memory Info	HP 8GB (2x4GB) DDR4-2400 ECC SO-DIMM
	Graphics Info	NVIDIA® Quadro® P1000M GPU
	Disks/Optical/Floppy	1x 1TB 7200 RPM SATA HDD

System Technical Specifications

	Power Supply	200W EPS					
	Other	Ethernet Capable					
Energy Consumption (Watts)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows long Idle (S0)	TBD		TBD		TBD	
	Windows short Idle (S0)	TBD		TBD		TBD	
	Windows Busy Typ(S0)	TBD		TBD		TBD	
	Windows Busy Max (S0)	TBD		TBD		TBD	
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
	Zero Power Mode (ErP)	TBD		TBD		TBD	

		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
Heat Dissipation (Btu/hr)	Windows long Idle (S0)	TBD		TBD		TBD	
	Windows short Idle (S0)	TBD		TBD		TBD	
	Windows Busy Typ(S0)	TBD		TBD		TBD	
	Windows Busy Max (S0)	TBD		TBD		TBD	
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
	Zero Power Mode (ErP)	TBD		TBD		TBD	

Z2 Mini G4	Processor Info	1x Intel® Core™ i7-6700 3.4 8M 4C
Configuration #3 (TBD)	Memory Info	32GB (2x16GB) DDR4-2400 nECC SO-DIMM
ENERGY STAR	Graphics Info	Intel® HD Graphics 530
CERTIFIED	Disks/Optical/Floppy	1x 1TB 7200 RPM SATA HDD / 1x Z Turbo Drive G2 512GB PCIe 1st SSD
	Power Supply	135W EPS
	Other	Ethernet Capable

		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Energy Consumption (Watts)	Windows long Idle (S0)	TBD		TBD		TBD	
	Windows short Idle (S0)	TBD		TBD		TBD	
	Windows Busy Typ(S0)	TBD		TBD		TBD	
	Windows Busy Max (S0)	TBD		TBD		TBD	
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
	Zero Power Mode (ErP)	TBD		TBD		TBD	

		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
Heat Dissipation (Btu/hr)	Windows long Idle (S0)	TBD		TBD		TBD	
	Windows short Idle (S0)	TBD		TBD		TBD	
	Windows Busy Typ(S0)	TBD		TBD		TBD	
	Windows Busy Max (S0)	TBD		TBD		TBD	
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
	Zero Power Mode (ErP)	TBD		TBD		TBD	

System Technical Specifications

Z2 Mini G4	Processor Info	1x Intel® Core™ i3-6100 3.7 3M 2C
Configuration #4 (TBD)	Memory Info	32GB (2x16GB) DDR4-2400 nECC SO-DIMM
ENERGY STAR	Graphics Info	NVIDIA® Quadro® P1000M GPU
CERTIFIED	Disks/Optical/Floppy	1x 1TB 7200 RPM SATA HDD / 1x Z Turbo Drive G2 512GB PCIe 1st SSD
	Power Supply	200W EPS
	Other	Ethernet Capable

Energy Consumption (Watts)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows long Idle (S0)	TBD		TBD		TBD	
	Windows short Idle (S0)	TBD		TBD		TBD	
	Windows Busy Typ(S0)	TBD		TBD		TBD	
	Windows Busy Max (S0)	TBD		TBD		TBD	
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
	Zero Power Mode (ErP)	TBD		TBD		TBD	

Heat Dissipation (Btu/hr)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
	Windows long Idle (S0)	TBD		TBD		TBD	
	Windows short Idle (S0)	TBD		TBD		TBD	
	Windows Busy Typ(S0)	TBD		TBD		TBD	
	Windows Busy Max (S0)	TBD		TBD		TBD	
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
	Zero Power Mode (ErP)	TBD		TBD		TBD	

Z2 Mini G4	Processor Info	1x Intel® Core™ i3-6100 3.7 3M 2C
Configuration #5 (TBD)	Memory Info	4GB (1x4GB) DDR4-2400 nECC SO-DIMM
	Graphics Info	Intel® HD Graphics 630
	Disks/Optical/Floppy	1x 1TB 7200 RPM SATA HDD
	Power Supply	135W EPS
	Other	Ethernet Capable

Energy Consumption (Watts)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows long Idle (S0)	TBD		TBD		TBD	
	Windows short Idle (S0)	TBD		TBD		TBD	
	Windows Busy Typ(S0)	TBD		TBD		TBD	
	Windows Busy Max (S0)	TBD		TBD		TBD	
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
	Zero Power Mode (ErP)	TBD		TBD		TBD	

Heat Dissipation (Btu/hr)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
	Windows long Idle (S0)	TBD		TBD		TBD	
	Windows short Idle (S0)	TBD		TBD		TBD	
	Windows Busy Max (S0)	TBD		TBD		TBD	

System Technical Specifications

Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD
Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
Zero Power Mode (ErP)	TBD		TBD		TBD	

System Technical Specifications

Declared Noise Emissions Z2 Mini G4 (Entry)

Declared Noise Emissions (Entry-level and High-end configurations)

System Configuration (Entry level With HDD)	Processor Info	Intel® Core™ i3-8100 3.6G/6M/4c
	Memory Info	1 - 4GB DDR4-2666 SO-DIMM Memory
	Graphics Info	iGfx
	Disks/SSD	1 - Hitachi 500GB SATA 7200RPM HDD 1 - Samsung 256GB PCIe M.2 SSD

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
Idle	3.08	16.2
Hard drive Operating (random reads)	3.08	17.1

System Configuration (Entry level Only SSD)	Processor Info	Intel® Core™ i3-8100 3.6G/6M/4c
	Memory Info	1 - 4GB DDR4-2400 SO-DIMM Memory
	Graphics Info	iGfx
	Disks/SSD	N / A 1 - Samsung 256GB PCIe M.2 SSD

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
Idle	2.97	11.7
Hard drive Operating (random reads)	/	/

System Configuration (High-end)	Processor Info	Intel® Core™ i7-8700 4.6G/12M/6c
	Memory Info	2 - 8GB DDR4-2666 SO-DIMM Memory
	Graphics Info	iGfx
	Disks/SSD	1 - Hitachi 1TB SATA 7200RPM HDD 1 - Samsung 512GB PCIe M.2 SSD

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
Idle	3.14	19.2
Hard drive Operating (random reads)	3.18	19.4

Declared Noise Emissions Z2 Mini G4 Performance

Declared Noise Emissions (Entry-level and High-end configurations)

System Configuration (Entry level With HDD)	Processor Info	Intel® Core™ i3-8100 SR2HG/3.6G/6M/4c
	Memory Info	1 - 4GB DDR4-2666 SO-DIMM Memory
	Graphics Info	NVIDIA® Quadro® 600

System Technical Specifications

	Disks/SSD	1 - Hitachi 500GB SATA 7200RPM HDD 1 - Samsung 256GB PCIe M.2 SSD	
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.16	20.3
	Hard drive Operating (random reads)	3.17	20.4
System Configuration (Entry level Only SSD)	Processor Info	Intel® Core™ i3-8100 SR2HG/3.6G/6M/4c	
	Memory Info	1 - 4GB DDR4-2666 SO-DIMM Memory	
	Graphics Info	NVIDIA® Quadro® P600	
	Disks/SSD	N / A 1 - Samsung 256GB PCIe M.2 SSD	
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.06	19.1
	Hard drive Operating (random reads)	/	/
System Configuration (High-end)	Processor Info	Intel® Xeon® E-2144 QJ70/3.6G/8M/4c	
	Memory Info	2 - 8GB DDR4-2666 SO-DIMM Memory	
	Graphics Info	NVIDIA® Quadro® P600	
	Disks/SSD	1 - Hitachi 1TB SATA 7200RPM HDD 1 - Samsung 512GB PCIe M.2 SSD	
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.21	22.2
	Hard drive Operating (random reads)	3.23	22.7

System Technical Specifications

Environmental Requirements	Temperature	Operating: 40° to 95° F (5° to 35° C) Non-operating: -40° to 140° F (-40° to 60° C)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 10,000 feet (3,000 m) Non-operating: 30,000 feet (9,100 m)
	Dynamic (new)	Shock Operating: ½-sine: 40g, 2-3ms Non-operating: ½-sine: 160 cm/s, 2-3ms (~100g) square: 422 cm/s, 20g Vibration Operating random: 0.5g (rms), 5-300 Hz Non-operating random: 2.0g (rms), 10-500 Hz
	Cooling	Notes: Values represent individual shock events and do not indicate repetitive shock events. Values do not indicate continuous vibration. Above 5,000 ft (1524 m) altitude, maximum operating temperature is de-rated by 1.8° F (1° C) per 1,000 ft (305 m) elevation increase

System Technical Specifications

Physical Security and Serviceability

Access Panel	Tool-less Includes system board and memory information
Hard Drives	HDD cage requires the use of a screwdriver to remove the HDD
Expansion Cards	M.2 module requires a screwdriver to service and replace.
Processor Socket	Tool-less, except for the processor heatsink.
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Screw-In
Dual Color Power and HD LED on Front of Computer	The Power LED is on the front of the system, but the HDD LED is located on the Rear of the system
Configuration Record SW	Yes
Over-Temp Warning on Screen	Yes
Restore CD/DVD Set	Consists of an operating system DVD (OSDVD) and a driver DVD (DRDVD). OSDVD restores the original operating system. DRDVD will provide all drivers for the system. The DRDVD may also contain applications that originally shipped with the system for optional installation. Applications can also be obtained from HP.com. OSDVD and DRDVD are orderable with the system and available from HP Support.
Dual Function Front Power Switch	Yes, causes a fail-safe power off when held for 4 seconds (default) or 15 seconds (can be configured by F10 BIOS setup\Advanced\System Options\Power button override)
Cable Lock Support	Yes, Kensington Cable Lock (optional): Locks top cover from being opened and secures chassis to furniture to prevent theft 3 mm x 7 mm slot at rear of system
Serial, Parallel, USB, Audio, Network, Enable/Disable Port Control	Yes, enables or disables serial, USB, audio, and network ports (parallel port is not supported on the Z2 Mini G4 G4)
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration

System Technical Specifications

NIC LEDs (integrated) (Green & Amber)	Yes
CPUs and Heatsinks	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less
Power Supply Diagnostic LED	Yes; this is located on the Rear of the chassis and combined with the HDD LED. When the PSU adapter is plugged in, and the unit is powered off, the Power OK LED will glow.
Front Power LED	Yes, white (normal), red (fault)
Internal Speaker	Yes, on the side of the chassis
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS.
Cooling Solution	Air cooled forced convection
CPU Heatsink Fan	Z2 Mini G4 Entry & Performance CPU blower solution: 11.1 mm x 65mm x 82.1mm Z2 Mini G4 Performance GPU blower solution: 29mm x 103.6mm x 102.2mm
Chassis Fan	Z2 Mini G4 Entry: Single system blower Z2 Mini G4 Performance: Dual system blower
Memory Heatsink Fan	No
HP PC Hardware Diagnostics UEFI	HP PC Hardware Diagnostics (UEFI) enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support.
Access Panel Key Lock	The Kensington lock slot on the chassis serves this purpose
ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI). <ul style="list-style-type: none"> • Allows the system to wake from a low power mode. • Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system
Trusted Platform Module Chip	Yes
M.2 Card Retention	Yes, all M.2 modules are retained by a single screw
Flash ROM	Yes
Diagnostic Power Switch LED on board	Yes
Clear Password Jumper	Yes
Clear CMOS Jumper	Yes

System Technical Specifications

CMOS Battery Holder	Yes: Z2 Mini G4 Entry Yes: Z2 Mini G4 Performance
DIMM Connectors	Yes
BIOS (TBD)	
BIOS 32-bit Services	Standard BIOS 32-bit Service Directory Proposal v0.4
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces.
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0.
BBS	BIOS Boot Specification v1.01. Provides more control over how and from what devices the workstation will boot.
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.
BIOS Power On	Users can define a specific day-of-week and time for the system to power on.
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS.
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM.
Replicated Setup	Saves BIOS settings to USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).
SMBIOS	System Management BIOS 2.7.1, for system management information.
Boot Control	Disables the ability to boot from removable media on supported devices.
Memory Change Alert	Alerts management console if memory is removed or changed.
Thermal Alert	Monitors the temperature state within the chassis. Three modes: <ul style="list-style-type: none">• NORMAL - normal temperature ranges.• ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.• SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console. Updates can be performed before starting the OS. Updates can be periodically scheduled.

System Technical Specifications

ACPI (Advanced Configuration and Power Management Interface)	Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 4.0 for full compatibility with 64-bit operating systems.
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location.
ASF 2.0 Compliant	Yes.
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time.
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system.
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.
System board revision level	Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing.
Auto Setup when new hardware installed	System automatically detects addition of new hardware.
Keyboard-less Operation	The system can be booted without a keyboard.
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.
Asset Tag	The user or IT administrator to set a unique tag string in non-volatile memory.
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable) to be configured individually.
Adaptive Cooling	Control parameters are set according to detected hardware configuration for optimal acoustics.
Pre-boot Diagnostics	(Pre-video) critical errors are reported via beeps and blinks on the power LED.
Digitally and Cryptographically Signed BIOS	Helps to prevent the installation of unauthorized versions of a BIOS (a rogue BIOS) from a virus, malware, or other code that could lead to compromised system security, data access, physical service, or even system board replacement.

System Technical Specifications

Master Boot Record Protection	A feature in the HP BIOS that prevents changes and/or infections to the Master Boot Record. Useful in protecting from viruses.
Boot Block Emergency Recovery Mode (BIOS Recovery)	The HP BIOS offers a write-protected boot block ROM that provides recovery from a failed flashing of the computer BIOS. This special recovery mode prevents the system from becoming unusable or “bricked” when a BIOS update is interrupted.
Industry Standard Specification Support	
Industry Standard	Revision Supported by the BIOS
UEFI Specification Revision	UEFI 2.4.0
ACPI	Advanced Configuration and Power Management Interface, Version 4.0
ASF	Alert Standard Format Specification, Version 2.0
EDD	- Enhanced Disk Drive Specification Version 1.1 - BIOS Enhanced Disk Drive Specification Version 3.0
PCI Express	PCI Express Base Specification, Revision 2.0; PCI Express Base Specification, Revision 3.0.
PMM	POST Memory Manager Specification, Version 1.01
SATA	- Serial ATA Specification, Revision 1.0a - Serial ATA II: Extensions to Serial ATA 1.0, Revision 1.0a - Serial ATA II Cables and Connectors Volume 2 Gold - SATA-IO SATA Revision 3.0 Specification
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B
TPM	Trusted Computing Group TPM Specification Version 2.0
USB	Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.1 Specification

System Technical Specifications

Social and Environmental Responsibility

Eco-Label Certifications & Declarations This product is low halogen except for power cords, cables and peripherals. Service parts obtained after purchase may not be Low Halogen.

- ENERGY STAR® (energy-saving features available on selected configurations –Windows® only)
- US Federal Energy Management Program (FEMP)
- China Energy Conservation Program (CECP)
- IT ECO declaration

Batteries

The battery in this product complies with EU Directive 2006/66/EC
Battery size: CR2032 (coin cell)
Battery type: Lithium Metal

The battery in this product does not contain:

- Mercury greater than 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 40ppm by weight

Restricted Material Usage This product meets the material restrictions specified in HP's General Specification for the Environment. <http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf>
HP Inc. is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.

Low Halogen Statement This product is low halogen except for power cords, cables and peripherals, as well as the following customer-configurable internal components: Creative Recon3D PCIe Audio Card is not Low Halogen. Service parts obtained after purchase may not be Low Halogen.

End-of-Life Management and Recycling HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <http://www.hp.com/recycle> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.

HP Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:
Living Progress Report <http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html>

Eco-label certifications
<http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html>

ISO 14001 certificates:
<http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html>

Additional Information

- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product is >90% recycle-able when properly disposed of at end of life
- EPEAT® Gold registered in the U.S. EPEAT registration varies by country. See <http://www.epeat.net> for registration status by country.

System Technical Specifications

Packaging

HP Workstation product packaging meets the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/society/gen_specifications.html

- Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment
- Does not contain ozone-depleting substances (ODS)
- Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed
- Maximizes the use of post-consumer recycled content materials in packaging materials
- All packaging material is recyclable
- All packaging material is designed for ease of disassembly
- Reduced size and weight of packages to improve transportation fuel efficiency
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting

Packaging Materials**Internal**

Cushions made from fabricated recycled expanded-polyethylene (EPE) or recycled expanded-polypropylene (EPP). May also be made from recycled molded paper-pulp (MPP).

External

Carton made from corrugated fiberboard with at least 35% recycled content.

System Technical Specifications

Manageability

Intel® Active Management Technology (AMT) The HP Z2 Mini G4 workstation supports Intel® vPro™ technology when purchased with a vPro™ technology capable CPU: Intel® Xeon® E-2100 processor family or 8th Generation Intel® Core™ i5/i7 processors with Intel® VT-d/VT-x and Intel® TXT technology.

Remote Manageability Software Solutions Visit: <http://www.hp.com/go/easydeploy>

System Software Manager Visit: <http://www.hp.com/go/ssm>

Service, Support, and Warranty

- Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.
 - PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.
 - Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.
-

Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost, no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	Product #	Offering
		Intel® Xeon E-2124 3.4 8M GT2 4C
		Intel® Xeon E-2144 3.6 8M GT2 4C

Hard Drives	Product #	Offering
		HDD 1TB 7200RPM SATA 2.5
		SSD 512GB TLC M.2

Graphics	Product #	Offering
		Nvidia® Quadro® P600 4GB graphics

Technical Specifications - Processors

Intel® Xeon® processor E-2100 family

Intel® Xeon® processor E-2176G

Intel® Xeon® processor E-2174G

Intel® Xeon® processor E-2144G

Intel® Xeon® processor E-2136

Intel® Xeon® processor E-2124G

Intel® Xeon® processor E-2104G

8th generation Intel® Core™ processor family

Intel® Core™ i7-8700 3.2 26666 6C CPU

Intel® Core™ i7+8700 (Core i7 and 16GB Intel® Optane™ memory) 3.2 26666 6C CPU*

Intel® Core™ i5-8600 3.1 2666 6C CPU

Intel® Core™ i5+8600 (Core i7 and 16GB Intel® Optane™ memory) 3.1 2666 6C CPU*

Intel® Core™ i5-8500 3.0 2666 6C CPU

Intel® Core™ i5+8500 (Core i7 and 16GB Intel® Optane™ memory) 3.0 2666 6C CPU*

8th generation Intel® Core™ i3/Pentium processor family

Intel® Core™ i3-8100 3.6 2400 4C CPU

Intel® Core™ i3+8100 (Core i7 and 16GB Intel® Optane™ memory) 3.6 2400 4C CPU

Intel® Pentium® G5400 3.7 2400 2C CPU

*Intel® Optane™ memory (cache) is sold separately. Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system. Available for HP commercial desktops and notebooks and for select HP workstations (HP Z240 Tower/SFF, Z2 Mini, ZBook Studio, 15 and 17 G5) and requires a SATA HDD, 7th Gen or higher Intel® Core™ processor or Intel® Xeon® processor E3-1200 V6 product family or higher, BIOS version with Intel® Optane™ supported, Windows 10 version 1703 or higher, M.2 type 2280-S1-B-M connector on a PCH Remapped PCIe Controller and Lanes in a x2 or x4 configuration with B-M keys that meet NVMe™ Spec 1.1, and an Intel® Rapid Storage Technology (Intel® RST) 15.5 driver.

Technical Specifications - Hard Drives

SATA Hard Drives for HP Workstations	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Capacity	500GB		
		Protocol	SATA		
		Form Factor	SFF (2.5")		
		Controller	AHCI		
		Rated for 24/7/365 operation	NO		
		Physical Size (Height)	0.28 in; .7 cm		
		Physical Size (Width)	2.75 in; 6.99 cm		
		Media Diameter	2.5 in; 6.36 cm		
		Interface	Serial ATA (6Gb/s), NCQ enabled		
		Synchronous Transfer Rate (Maximum)	Up to 600MB/s		
		Operating Temperature	32° to 140° F (0° to 60° C)		
			1TB SATA 7200 rpm 6Gb/s SFF HDD	Capacity	1TB
	Protocol	SATA			
	Form Factor	SFF (2.5")			
	Controller	AHCI			
	Rated for 24/7/365 operation	NO			
	Physical Size (Height)	0.28 in; .7 cm			
	Physical Size (Width)	2.75 in; 6.99 cm			
	Media Diameter	2.5 in; 6.36 cm			
	Interface	Serial ATA (6Gb/s), NCQ enabled			
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s			
	Operating Temperature	32° to 140° F (0° to 60° C)			
PCIe SSDs for HP Workstations	HP Z Turbo Drv G2 256GB TLC PCIe SSD (Z2 MB)	Capacity		256GB	
		Protocol	PCIe		
		Form Factor	M.2 in native slot on motherboard		
		Controller	NVMe		
		NAND Type	3D TLC		
		Endurance	75TBW (TB Written)		
		Reliability (MTBF)	1.5M hours		
		Interface	PCI Express 3.0 x4		
		Operating Temperature	32° to 158° F (0° to 70° C)		
		Performance	Sequential Read	2800 MB/s	
			Sequential Write	320 MB/s (1100 MB/s max/Turbo)	
			Random Read	250K IOPS	
			Random Write	180K IOPS	

Technical Specifications - Hard Drives

HP Z Turbo Drv G2 512GB TLC PCIe SSD (Z2 MB)	Capacity	512GB	
	Protocol	PCIe	
	Form Factor	M.2 in native slot on motherboard	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	150TBW (TB Written)	
	Reliability (MTBF)	1.5M hours	
	Interface	PCI Express 3.0 x4 electrical x4 physical	
	Operating Temperature	32° to 158° F (0° to 70° C)	
	Performance	Sequential Read	2800 MB/s
		Sequential Write	660 MB/s (1600 MB/s max/Turbo)
		Random Read	260K IOPS
		Random Write	260K IOPS
HP Z Turbo Drv G2 1TB TLC PCIe SSD (Z2 MB)	Capacity	1TB	
	Protocol	PCIe	
	Form Factor	M.2 in native slot on motherboard	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	300TBW (TB Written)	
	Reliability (MTBF)	1.5M hours	
	Interface	PCI Express 3.0 x4	
	Operating Temperature	32° to 158° F (0° to 70° C)	
	Performance	Sequential Read	3000 MB/s
		Sequential Write	1150 MB/s (1700 MB/s max/Turbo)
		Random Read	360K IOPS
		Random Write	330K IOPS

Technical Specifications - Graphics

Integrated Intel® HD Graphics (Z2G4)	Form Factor	Integrated in select Intel® Xeon® E, Intel® Core™ i7, Intel® Core™ i5, and Intel® Core™ i3 processors. Check specific platform specifications for selections.
	Graphics Controller	Intel® UHD Graphics
	Memory	Unified Memory Architecture (UMA) frame buffer. Graphics memory is shared with system memory. Size selectable between 32 MB to 1024 MB via BIOS setting. Default size is 128 MB. Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (Intel® DVMT), to provide an optimal balance between graphics and system memory use.
	Connectors	Check system platform specifications where Intel® HD Graphics are available.
	Maximum Resolution	DisplayPort™ 1.2: - up to 4096x2160 x 24 bpp @ 60Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) HDMI 2.0 output: - up to 4096x2160 x 24 bpp @ 60Hz Dual Link DVI(I) output: - up to 2560 x 1600 x 32 bpp @ 60Hz Single Link-DVI(I) output: - up to 1920 x 1200 x 32 bpp @ 60Hz VGA output: - 2048 x 1536 x 32 bpp @ 85 Hz Note: For HDMI, DVI, and VGA outputs, separate adapters required.
	Shading Architecture	Shader Model 5.0
	Supported Graphics APIs	OpenGL 4.4 DirectX 12
	Available Graphics Drivers	Windows 10

*Integrated graphics will depend on processor. HD content required to view HD images

Technical Specifications - Graphics

NVIDIA® Quadro® P1000M Maximum Resolution 4GB Graphics

DisplayPort™ 1.2:
- up to 4096x2160 x 30 bpp @ 60Hz
- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

HDMI 2.0 output:
- up to 4096x2160 x 30 bpp @ 60Hz

Image Quality Features Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology, 3D DLP, Interleaved, and passive stereo

Display Output Maximum number of displays:
- 4 direct attached monitors

Maximum number of DisplayPort™ displays possible per DisplayPort™ output (Multiple displays daisy-chained from one DisplayPort™ 1.2 port requires DisplayPort™ 1.2 MST capable displays or DisplayPort™ 1.2 MST capable hub):
- 4 1920x1200 @ 60 Hz
- 2 2560x1600 @ 60 Hz
- 1 4096x2160 @ 60 Hz

Maximum number of monitors across all available NVIDIA® Quadro® outputs is 4.

Supported Graphics APIs OpenGL 4.5
DirectX 12

API support includes:
CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics Drivers Microsoft Windows 10
Linux - Full OpenGL implementation, complete with NVIDIA® and ARB extensions

HP qualified drivers may be preloaded or available from the HP support Web site:
<http://welcome.hp.com/country/us/en/support.html>

NVIDIA® Quadro® P600 4GB Graphics

Maximum Resolution DisplayPort™ 1.2:
- up to 4096x2160 x 30 bpp @ 60Hz
- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

HDMI 2.0 output:
- up to 4096x2160 x 30 bpp @ 60Hz

Image Quality Features Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology, 3D DLP, Interleaved, and passive stereo

Display Output Maximum number of displays:
- 4 direct attached monitors

Technical Specifications - Graphics

Maximum number of DisplayPort™ displays possible per DisplayPort™ output (Multiple displays daisy-chained from one DisplayPort™ 1.2 port requires DisplayPort™ 1.2 MST capable displays or DisplayPort™ 1.2 MST capable hub):

- 4 1920x1200 @ 60 Hz
- 2 2560x1600 @ 60 Hz
- 1 4096x2160 @ 60 Hz

Maximum number of monitors across all available NVIDIA® Quadro® outputs is 4.

Supported Graphics APIs OpenGL 4.5
DirectX 12

API support includes:
CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics Drivers

Microsoft Windows 10
Linux - Full OpenGL implementation, complete with NVIDIA® and ARB extensions

HP qualified drivers may be preloaded or available from the HP support Web site:

<http://welcome.hp.com/country/us/en/support.html>

**AMD Radeon™ Pro WX
4150 4GB Graphics**

Maximum Resolution

DisplayPort™ 1.2:
- up to 4096x2160 x 30 bpp @ 60Hz
- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

HDMI 2.0 output:
- up to 4096x2160 x 30 bpp @ 60Hz

Image Quality Features

Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology, 3D DLP, Interleaved, and passive stereo

Display Output

Maximum number of displays:
- 4 direct attached monitors

Maximum number of DisplayPort™ displays possible per DisplayPort™ output (Multiple displays daisy-chained from one DisplayPort™ 1.2 port requires DisplayPort™ 1.2 MST capable displays or DisplayPort™ 1.2 MST capable hub):

- 4 1920x1200 @ 60 Hz
- 2 2560x1600 @ 60 Hz
- 1 4096x2160 @ 60 Hz

Maximum number of monitors across all available NVIDIA® Quadro® outputs is 4.

Supported Graphics APIs OpenGL 4.5
DirectX 12

Technical Specifications - Graphics

Available Graphics Drivers

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Microsoft Windows 10

Linux - Full OpenGL implementation, complete with NVIDIA® and ARB extensions

HP qualified drivers may be preloaded or available from the HP support Web site:

<http://welcome.hp.com/country/us/en/support.html>

Technical Specifications - Optical and Removable Storage

HP External Ultra-Slim DVD-RW Drive	Description	External 9.5mm high, tray-load
	Mounting Orientation	Either horizontal or vertical
	Interface Type	USB 2.0
	Dimensions (WxHxD)	144 x 14 x 137.5mm
	Supported Media Types	DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW
	Disc Capacity	DVD-ROM 8.5 GB DL or 4.7 GB standard
	Access Times	Full Stroke DVD 160ms (typical for Random Stroke)
		Full Stroke CD 140ms (typical for Random Stroke)
	Maximum Data Transfer Rates	CD ROM Read CD-ROM, CD-R Up to 24X CD-RW Up to 24X
		DVD ROM Read DVD-RAM Up to 8X DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X
Power		Source USB 2.0 DC power
		DC Power Requirements 5 VDC ± 5%-100 mV ripple p-p
Operating Environmental (all conditions non-condensing)	Temperature 41° to 104° F (5° to 40° C)	
	Relative Humidity 15% to 80%	
	Maximum Wet Bulb Temperature 84° F (29° C)	
Operating Systems Supported	Windows 10 32-bit and 64-bit, Windows 8 32-bit and 64-bit, Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation, Removed reference to "Novell" because of acquisition and changed product reference to "SUSE Linux Enterprise Desktop 10 & 11",	
	No driver is required for this device. Native support is provided by the operating system.	
Kit Contents	HP External Ultra-Slim DVD-RW Drive DVD Writer drive, USB 2.0 type A to mini-B cable. © Copyright 2018 HP Development Company, L.P.	

Technical Specifications - Optical and Removable Storage

The only warranties for HP products and services are set forth in the express warranty statements accompanying such products and services. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein. The information contained herein is subject to change without notice.

Technical Specifications - Networking and Communications

Integrated Intel® I219LM PCIe GbE Controller (Intel® vPro™ with Intel® AMT 11.0)	Connector	RJ-45
	Controller	Intel® I219LM GbE platform LAN connect networking controller
	Memory	3 KB Tx and 3KB Rx FIFO packet buffer memory
	Data Rates Supported	10/100/1000 Mbps
	Compliance	802.1as/1588, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3i, 802.3u, 802.3z
	Bus Architecture	PCI Express and SMBus
	Data Transfer Mode	PCIe-based interface for active state operation (S0 state) and SMBus for host and management traffic (Sx low power state)
	Power Requirement	Requires 3.3V (integrated regulators for core Vdc)
	Boot ROM Support	Yes
	Network Transfer Mode	Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
	Management Capabilities	vPro, WOL, auto MDI crossover, PXE, Multi-port teaming, RSS, ACPI, Advanced cable diagnostic, loopback modes, AMT 11.0 support, Circuit Breaker, VLAN, Multicast Listener Discovery (MLD)

Intel® 8265 Wireless LAN (802.11ac) and Bluetooth 4.2 Module	Connector	M.2 (Supports 2230 form factor; E Key) Motherboard Interface
	Controller	Intel® Dual Band Wireless-AC 8260
	Compliance	Wireless LAN: IEEE 802.11abgn, 802.11ac, 802.11d, 802.11e, 802.11i, 802.11h, 802.11w, CCX 4.x/CCX Lite, WMM, WPA, WPA2, APS, WPS 2.0, Protected Management Frames Bluetooth®: Dual Mode Bluetooth® 2.1, 2.1+EDR, 3.0, 4.0, BLE, and 4.2
	Bus Architecture	PCI Express Gen3 x1 and USB 2.0
	Power Requirement	Requires 3.3V ; 1.65W TDP
	Management Capabilities	Wake on WLAN (in all sleep states, excluding Max Power Savings mode), WFA Management Frame Protection (802.11w), vPro/WiAMT Not Currently Supported, F10 BIOS Menu option to disable/enable WLAN and Bluetooth® radios, supports seamless roaming between 802.11 wireless access points
	Throughput	Max PHY throughput 887 Mbps (802.11ac) for WLAN

Summary of Changes

HP Z2 Mini G4 VESA Sleeve	Mechanical	Dimensions (H x W x D)	Unpackaged	70 mm x 224 mm x 223 mm (2.75 x 8.81 x 8.77 in)	
			Packaged	305 x 102 x 289 -mm (12 x 4 x 11.38 in)	
		Weight		Unpackaged	1.7 kg (3.7 lb)
				Packaged	2.27 (5.0-lb)
	Other	Option kit contents	HP Z2 Mini G4 VESA Sleeve, mounting screws, installation guide, warranty card.		
Limited Warranty	The HP Z2 Mini G4 VESA Sleeve carries a one-year limited warranty. Technical support is available seven days a week, 24 hours a day, online and support forums. Certain restrictions and exclusions apply.				

HP Elite USB-C Docking Station (TBD)	Mechanical	Dimensions (H x W x D)	Unpackaged	TBD	
			Packaged	TBD	
		Weight		Unpackaged	TBD
				Packaged	TBD
	Other	Option kit contents	HP Z2 Mini G4 VESA Sleeve, mounting screws, installation guide, warranty card. TBD		
Limited Warranty	The HP Z2 Mini G4 VESA Sleeve carries a one-year limited warranty. Technical support is available seven days a week, 24 hours a day, online and support forums. Certain restrictions and exclusions apply. TBD				

Summary of Changes

Date of change:	Version History:		Description of change:
	From v1 to v2		

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